L Number	Hits	Search Text	DB	Time stamp
1	240	(427/335).CCLS.	USPAT;	2003/10/22 13:17
	"		US-PGPUB;	
1	1		EPO; JPO;	1 1
	ļ l		DERWENT;	ļ
1	}		IBM_TDB	1
2	475	(427/336).CCLS.	USPAT;	2003/10/22 13:12
1	i		US-PGPUB;	1 1
			EPO; JPO;	l l
ì	1		DERWENT;	1 1
			IBM_TDB	1
3	75	(((427/335).CCLS.) or ((427/336).CCLS.))	USPAT;	2003/10/22 13:18
		and (resist or photoresist or novolac)	US-PGPUB;	0
1 1	(EPO; JPO;	i
1			DERWENT;	l i
1 '	1 1		IBM_TDB	1
4	487	(427/340).CCLS.	USPAT;	2003/10/22 13:18
1	1 1		US-PGPUB;	(
İ			EPO; JPO;	1
1	1		DERWENT;	[
1			IBM_TDB	1
5	99	(((427/335).CCLS.) or ((427/336).CCLS.) or	USPAT;	2003/10/22 13:18
1		((427/340).CCLS.)) and (resist or	US-PGPUB;	
		photoresist)	EPO; JPO;	[
			DERWENT;	1
1 .	1		IBM_TDB	1 2000 (20 (20 12 20)
6	3	(((427/335).CCLS.) or ((427/336).CCLS.) or	USPAT;	2003/10/22 13:19
		((427/340).CCLS.)) and (solvent same	US-PGPUB;	
		PGMEA)	EPO; JPO;	J l
İ			DERWENT;	
1			IBM_TDB	1 0000 (10 (00 11 10)
1-	2	"6355198"	USPAT;	2003/10/22 11:48
1			US-PGPUB;	į J
1			EPO; JPO;	
			DERWENT;	į J
1		2002 461607 NDPN	IBM_TDB	2003/09/24 15:37
-	1 0	2002-461607.NRAN.	DERWENT	2003/09/24 15:37
-		6355198.URPN.	USPAT;	2003/10/21 13:40
-	25	(polymer and mold and capillary).clm.	US-PGPUB;	2003/10/21 13.40
1			EPO; JPO;	[
}			DERWENT;	1
			IBM TOB	1
1_	252	(polymer and mold and pattern).clm.	USPAT;	2003/09/24 15:42
1	232	(porymer and more and paccern).cim.	US-PGPUB;	2555,05724 25.42
1	1		EPO; JPO;	1 1
			DERWENT;	
1	1 -		IBM TDB	1 1
1_	46	(polymer and mold and (heat adj	USPAT;	2003/09/24 15:43
1	10	treat\$4)).clm.	US-PGPUB;	======
			EPO; JPO;	
1	į i		DERWENT;	1
ì			IBM TDB	1
1_	41	((polymer or resin) and mold and	USPAT;	2003/09/24 15:43
1	, ,,	capillary).clm.	US-PGPUB;	
1	1		EPO; JPO;	
1			DERWENT;	į i
[í I		IBM TDB	(
-	0	("(capillaryandmicromolding).ti.").PN.	USPAT;	2003/09/24 15:44
	Ĭ		US-PGPUB;	1
			EPO; JPO;	
[- 20		DERWENT;	(
			IBM TDB	
Í - '	2	(capillary and micromolding).ab.	USPAT;	2003/09/24 15:45
			US-PGPUB;	
1	1		EPO; JPO;	[
			DERWENT;	ì
1	[IBM TDB	()
		<u> </u>		<u> </u>

-	3	(capillary and micromolding).ti,	USPAT; US-PGPUB;	2003/09/24 15:50
			EPO; JPO;	
ĺ			DERWENT; IBM TDB	
-	9	(micromolding).ti.	USPAT;	2003/09/24 15:45
l)		US-PGPUB; EPO; JPO;	
1		·	DERWENT;	
ĺ	22	(micromolding).ab.	IBM_TDB USPAT;	2003/09/24 15:45
_	- 22	(micromorality).ab,	US-PGPUB;	2000,03,21 20110
			EPO; JPO; DERWENT;	
			IBM_TDB	
-	20638	((polymer or resin) and molding).ti.	USPAT; US-PGPUB;	2003/09/24 15:47
ĺ		`	EPO; JPO;	1
		111	DERWENT; IBM TDB	1
_	293	whitesides.in.	USPAT;	2003/09/24 15:48
			US-PGPUB; EPO; JPO;	
			DERWENT;	
0	45	whitesides.in. and printing	IBM_TDB USPAT;	2003/09/24 15:52
	1 43	whitesides.in. and princing	US-PGPUB;	2003/03/24 13.32
		•	EPO; JPO; DERWENT;	
			IBM_TDB	· ·
-	22	(microcontact adj printing).ti.	USPAT; US-PGPUB;	2003/10/17 15:27
			EPO; JPO;	
			DERWENT; IBM TDB	
-	151	whitesides.in. and (polymer or resin)	USPAT;	2003/09/24 15:50
			US-PGPUB; EPO; JPO;	
		•	DERWENT;	
	10	(capillary and molding).ti.	IBM_TDB USPAT;	2003/09/24 15:50
	10	((capitially and mording).ci.	US-PGPUB;	2003/03/24 13.30
	1		EPO; JPO; DERWENT;	
j			IBM_TDB	
-	10	whitesides.in. and (PGMEA or novolac)	USPAT; US-PGPUB;	2003/10/21 11:49
			EPO; JPO;	ì
	}		DERWENT; IBM TDB	
-	102	(216/44).CCLS.	USPAT;	2003/09/24 15:58
			US-PGPUB; EPO; JPO;	
	İ		DERWENT;	
_	738	(216/2).CCLS.	IBM_TDB USPAT;	2003/09/24 15:56
	, , , ,	(220, 2, 1002)	US-PGPUB;	3.00
			EPO; JPO; DERWENT;	
			IBM_TDB	[/ /
-	34	("3873359" "3873360" "3900614" "4098922" "4100037" "4192764"	USPAT	2003/09/24 15:57
		"4258001" "4322457" "4472458"		
		"4508755" "4555414" "4637904" "4690715" "4710401" "4728591"		
		"4802951" "4869778" "4959252"		
		"5073495" "5079600" "5087510" "5141785" "5170461" "5227474"		
		"5259926" "5345869" "5385116"		
		"5393401" "5439829" "5471455" "5484324" "5512131" "5620850"		
L	L	"5976826").PN.		L

	,		l norm.	2003/09/24 15:58
-	242	(216/54).CCLS.	USPAT; US-PGPUB;	2003/09/24 13:38
1	Į i		EPO; JPO;	{
			DERWENT;	
(ì		IBM TDB	[[
)_	479	(216/33).CCLS.	USPAT;	2003/09/24 16:01
			US-PGPUB;	\
ł	1		EPO; JPO;	1
			DERWENT;	ì
í			IBM_TDB	
-	1052	(216/41).CCLS.	USPAT;	2003/09/24 16:02
			US-PGPUB;	ì
}	1		EPO; JPO;	! }
	1		DERWENT;	Į Į
1		1054 (050) 000	IBM_TDB	2003/09/24 16:03
	1938	(264/259).CCLS.	USPAT; US-PGPUB;	2003/09/24 10.03
[!		EPO; JPO;	[-
		·	DERWENT;	1 .
}	· '		IBM TDB	} ·
l _	1431	(264/299).CCLS.	USPAT;	2003/09/24 16:04
	1431	(204/255/100001	US-PGPUB;	
	[EPO; JPO;	1
ļ	1		DERWENT;	ļ j
1	1		IBM TDB	1
-	397	(264/330).CCLS.	USPAT;	2003/09/24 16:04
			US-PGPUB;	\
	1		EPO; JPO;	į i
	j		DERWENT;	
			IBM_TDB	
-	532	(264/331.11).CCLS.	USPAT;	2003/09/24 16:04
	1		US-PGPUB;	1
· ·	1		EPO; JPO;	1
	j		DERWENT;	Ţ
	000	(05d: muint(3) ti	IBM_TDB USPAT;	2003/10/17 15:28
1~	829	(\$5contact adj print\$3).ti.	US-PGPUB;	2003/10/11 13:20
			EPO; JPO;	1
1	1	· And · And	DERWENT;	1 1
)	J		IBM TDB	j
_	52	(\$5contact adj print\$3).ti. and polymer	USPAT;	2003/10/17 15:28
}	1	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	US-PGPUB;	1
	1		EPO; JPO;	
1	1	*	DERWENT;	{
			IBM_TDB	1 1
-	6	(\$5contact adj print\$3).ti. and capillary	USPAT;	2003/10/17 15:29
1	1		US-PGPUB;	
	i		EPO; JPO;	1
1	1		DERWENT;	1
			IBM_TDB	2002/10/17 15:00
(-	4	(\$5contact adj print\$3).ti. and capillary	USPAT;	2003/10/17 15:29
]	1	and polymer	US-PGPUB; EPO; JPO;	j
	1		DERWENT;	1
l.			IBM TDB	1
1_	10	whitesides.in. and (novolac)	USPAT;	2003/10/21 11:49
-	1	whitesiaes.in. and (novotae)	US-PGPUB;	2000, 20, 21 21.49
Ì			EPO; JPO;]
		0	DERWENT;	1
1	1		IBM TDB	1
_	1436	(polymer and capillary).ab.	USPAT;	2003/10/21 11:51
1		** * **********************************	US-PGPUB;	
	!		EPO; JPO;	
[1		DERWENT;	[
j]		IBM_TDB	1
	2	(polymer and capillary).ab. and PGMEA	USPAT;	2003/10/21 11:51
1)		US-PGPUB;	1
1	1	1	EPO; JPO;	1
i		ł		
			DERWENT; IBM TDB	

		,		1 0000 /10 /00 10 10 11
	1	whitesides.in. and (PGMEA)	USPAT; US-PGPUB;	2003/10/21 11:52
1 1	}		EPO; JPO;	}
	j		DERWENT;	J
!		*	IBM_TDB	
} - ·	145	photoresist with PGMEA	USPAT;	2003/10/21 18:55
)		US-PGPUB;	
			EPO; JPO; DERWENT;	[
1	1		IBM TDB	
-	645	photoresist with novolac	USPAT;	2003/10/21 16:21
!			US-PGPUB;	
1	{		EPO; JPO; DERWENT;	1
)	J		IBM TDB	j j
\ -	0	micomoulding near3 capillaries	USPĀT;	2003/10/21 13:24
1 .			US-PGPUB;	1
	ļ		EPO; JPO;	
1	1		DERWENT;]
1_ :	0	micromoulding near3 capillaries	IBM_TDB USPAT;	2003/10/21 13:25
	J	witchowoodating hears capititaties	US-PGPUB;	
	İ		EPO; JPO;	
1		17.0	DERWENT;	
		migramolding poor2 conillarios	IBM TDB	2003/10/21 13:39
1-	46	micromolding near3 capillaries	USPAT; US-PGPUB;	2003/10/21 13:39
1			EPO; JPO;	
			DERWENT;	
1	Ì		IBM_TDB	0000/40/55 50 55
1-	6	(micromolding near3 capillaries) and	USPAT;	2003/10/21 13:33
J	ļ	(novolac)	US-PGPUB; EPO; JPO;]
	Ì		DERWENT;	
1			IBM_TDB	
]-	18	(micromolding near3 capillaries) and	USPĀT;	2003/10/21 13:34
	İ	(photoresist)	US-PGPUB;	
1			EPO; JPO; DERWENT;	1
] .	J	9	IBM_TDB	
-	7	(micromolding near3 capillaries) and	USPAT;	2003/10/21 13:46
1		(inorganic with mold)	US-PGPUB;	1
1 .	J		EPO; JPO; DERWENT;)
1			IBM TDB	
-	25	(polymer and mold and capillar\$3).clm.	USPĀT;	2003/10/21 13:40
1	ļ		US-PGPUB;	
			EPO; JPO;	
1			DERWENT;	i i
1	0	(pourous adj silicon) with mold	USPAT;	2003/10/21 13:54
1	1 .	(pour ad day britadily wrote mora	US-PGPUB;	
1			EPO; JPO;	
1 .	j		DERWENT;	
	218	(silicon adj dioxide) with mold	IBM_TDB USPAT;	2003/10/21 13:57
-	218	(Silicon adj dioxide) with mord	US-PGPUB;	2003/10/21 13:3/
1)		EPO; JPO;	
ļ !			DERWENT;	
į .			IBM_TDB	
] -	399	("sio.sub.2") with mold	USPAT; US-PGPUB;	2003/10/21 13:57
			EPO; JPO;	0
			DERWENT;	
J .)		IBM_TDB	
	10	(silicon adj dioxide) with (mold and	USPAT;	2003/10/21 13:55
1	Ì	(porous or porosity))	US-PGPUB; EPO; JPO;	
j .			DERWENT;	
1			IBM TDB	
				

	19	[(B - 1 - 1 - 1 - 2 1 - 2 1 - 2 1 - 2 1 - 2 2 2 2 2 2 2 2 2 2	USPAT;	2003/10/21 13:55
-	19	("sio.sub.2") with (mold and (porous or porosity))	US-PGPUB;	2003/10/21 13:55
		polosicy//	EPO; JPO;	J)
1	ļ		DERWENT;	1
{	ĺ		IBM TDB	(
-	7	(silicon adj dioxide) adj mold	USPĀT;	2003/10/21 13:57
)			US-PGPUB;	J)
1		,	EPO; JPO;	1
ĺ	ĺ		DERWENT;	(
1			IBM_TDB	
-	18	("sio.sub.2") adj mold	USPAT;	2003/10/21 13:57
			US-PGPUB;	ì
1	Ì		EPO; JPO; DERWENT;	ĺ
}			IBM TDB	,
_	2	("6329211").PN.	USPAT;	2003/10/21 14:32
	ĺ	(0023222) 12111	US-PGPUB;	1
ì			EPO; JPO;	(
	Į		DERWENT;	}
	J		IBM_TDB	j l
j -	2	photoresist with novolac with PGMEA	USPAT;	2003/10/21 16:22
1	(US-PGPUB;	
1	{		EPO; JPO;	}
]	j		DERWENT;]
1_	5	photoresist same novolac same PGMEA	IBM_TDB USPAT:	2003/10/21 17:09
(-	1 3	Duororestsc same novotac same rompy	US-PGPUB;	2003/10/21 1/:09
1	1		EPO; JPO;	
Ì			DERWENT;	
			IBM TDB	1
-	3090	damascene and photoresist	USPAT;	2003/10/21 17:10
į.)	a a	US-PGPUB;	
			EPO; JPO;	
	ĺ		DERWENT;	
Ì			IBM_TDB	
_	679	damascene and photoresist and copper and	USPAT;	2003/10/21 17:14
	ļ	wiring and pattern	US-PGPUB;	
	[EPO; JPO; DERWENT;	[
ł	ĺ		IBM TDB	ľ
ļ _	9397	copper adj clad\$4	USPAT;	2003/10/21 17:13
			US-PGPUB;	
			EPO; JPO;	4
(Ì		DERWENT;	(
1	24.5		IBM_TDB	
]-	1101	(216/13).CCLS.	USPAT;	2003/10/21 17:15
1			US-PGPUB;	
1	(EPO; JPO; DERWENT;	·
1 .	}		IBM TDB	}
1 - !	335	((216/13).CCLS.) and (resist or	USPĀT;	2003/10/21 17:17
1		photoresist) and copper	US-PGPUB;	
[Ì	1	EPO; JPO;	
1		· ·	DERWENT;	. {
!			IBM_TDB	J J
-	244	((216/13).CCLS.) and (resist or	USPAT;	2003/10/21 17:18
[photoresist) and pattern with (wiring or	US-PGPUB;	
		conduct\$3)	EPO; JPO;	
) .] .		DERWENT; IBM TDB)
_	345	photoresist with (novolac adj resin)	USPAT;	2003/10/21 18:15
ĺ	313	photococcoc with (novoldo dd) losin)	US-PGPUB;	2003, 10, 21 10.19
	}		EPO; JPO;	
J			DERWENT;	
		<u> </u>	IBM TDB	
-	15	(photoresist same (novolac adj resin)) and	USPAT;	2003/10/21 18:27
1		PGMEA	US-PGPUB;	
]			EPO; JPO;	
1			DERWENT;	
			IBM TDB	

Page 5

				0000740704
~	10	photoresist and (PGMEA with evaporat\$3)	USPAT;	2003/10/21 18:23
0.1			US-PGPUB; EPO; JPO;	
			DERWENT;	
ı			IBM TDB	
	35	photoresist and (PGMEA same evaporat\$3)	USPAT;	2003/10/21 18:36
	, ,,	photogesise and (remain same evaporation)	US-PGPUB;	
			EPO; JPO;	ſ
	ì		DERWENT;	1
	ł		IBM_TDB	
. –	36	(photoresist same novolac) and PGMEA	USPAT;	2003/10/21 18:27
	,		US-PGPUB;	i
		••	EPO; JPO;	
	1		DERWENT;	
		(.b.)	IBM_TDB USPAT;	2003/10/21 18:34
-	38	(photoresist same novolac\$1) and PGMEA	US-PGPUB;	2003/10/21 16.34
}	ł		EPO; JPO;	}
	1		DERWENT;	
	Ì		IBM TDB	}
i _	107	photoresist and (PGMEA same heat\$3)	USPAT;	2003/10/21 18:28
	~	1	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	(
			IBM_TDB	0000/10/01 10 00
- **	23	photoresist and (PGMEA with heat\$3)	USPAT;	2003/10/21 18:29
}	1		US-PGPUB; EPO; JPO;	
})		DERWENT;	
	Ì		IBM TDB	1
(_	27	(photoresist same fluidiz\$3) and	USPAT;	2003/10/21 18:35
į	2'	(evaporat\$3 or vapor\$5)	US-PGPUB;	=====================================
}		,	EPO; JPO;	
}			DERWENT;	
)	!		IBM_TDB	
) -	15	PGMEA same evaporat\$3 same resin	USPAT;	2003/10/21 18:42
ì	l		US-PGPUB;	
{	(EPO; JPO;	(
(Ì		DERWENT; IBM TDB	(
{ _	39	(PGMEA or polymer or resin or solvent) and	USPAT;	2003/10/21 18:46
-	39	(sealed adj vessel) and photoresist	US-PGPUB;	2003/10/21 10:40
}	}	(source and vesser) and photoresist	EPO; JPO;	1
)	}		DERWENT;)
			IBM TDB	
-	1720	(PGMEA or polymer or resin or solvent) and	USPAT;	2003/10/21 18:46
[((sealed adj vessel) and (diffus\$5 or	US-PGPUB;	
1		permeat\$5 or evaporat\$3)	EPO; JPO;	i
}	1		DERWENT;	
)		//PCMPA	IBM_TDB	2003/10/21 18:48
_	22	((PGMEA or polymer or resin or solvent) and (sealed adj vessel) and (diffus\$5 or	USPAT; US-PGPUB;	2003/10/21 18:48
		and (sealed adj vessel) and (dilluss) or permeat\$5 or evaporat\$3)).ab.	EPO; JPO;	
		permeded of evaporacidallian.	DERWENT;	
ĺ	(IBM TDB	(
-	484	(solvent and (polymer or photoresist)) and	USPAT;	2003/10/21 18:52
}	1	(sealed adj vessel) and (diffus\$5 or	US-PGPUB;	1
}	}	permeat\$5 or evaporat\$3)	EPO; JPO;	}
ļ			DERWENT;	}
,	1	J	IBM_TDB	
-	258	(solvent and (polymer or photoresist)) and	USPAT;	2003/10/21 18:50
ĺ	((sealed adj vessel) and (diffus\$5 or	US-PGPUB;	(
ì	1	permeat\$5)	EPO; JPO;	1
}	1		DERWENT; IBM TDB	1
_	R	(solvent and (polymer and photoresist))	USPAT;	2003/10/21 18:51
	٥ -	and (sealed adj vessel) and (diffus\$5 or	US-PGPUB;	2000, 10, 22 20.01
		permeat\$5)	EPO; JPO;	
		<u> </u>	DERWENT;	
i	(<u> </u>	IBM TDB	
		<u></u>		

116					T 0000 100 100	
FPO	~	116			2003/10/21 18	:53
Comparison of the comparison	i	ì	(resin or polymer or photoresist)		Ì	ì
166 Photoresist and PGMEA USPRT; USPRT		ì	*		}	ł
166 Photoresist and FGMEA USFAT; US-RGUBS EPO JPC) USFAT; US-RGUBS EPO JPC) USFAT; US-RGUBS EPO JPC) USFAT; US-RGUBS EPO JPC) USFAT; US-RGUBS EPO JPC) USFAT; US-RGUBS EPO JPC) USFAT; US-RGUBS EPO JPC) USFAT; US-RGUBS EPO JPC) USFAT; USFA)	}
US-PGUIDS FROD JPC DERMENT; IBM TOB USPAT	-	679	photoresist and PGMEA		2003/10/21 18	:55
- 166 photoresist and PGMEA and (diffusion) - 9 [fluidizing and polymer).ti.				US-PGPUB;		
TEM TOB				EPO; JPO;		Į
166 Photoresist and FGMEA and (diffusion) USPAT; US-FGFUB; EPG, JPG; DERWRNT; IRK TDS USPAT; USPAT; US-FGFUB; EPG, JPG; DERWRNT; IRK TDS USPAT; USPA				DERWENT;	((
Second S		Ì				!
FPO, JPO; DERWINT; IRM, TDB (USPAT); US-GEOB; EPO, JPO; DERWINT; IRM, TDB (USPAT); US-GEOB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; DERWINT; IBM TDB (USPAT); US-GEOBB; EPO, JPO; USPAT); US-GEOBB; EPO, JPO; USPAT; US-GEOBB; EPO, JPO; USPAT; US-GEOBB; EPO, JPO; USPAT; US-GEOBB; EPO, JPO; USPAT; US-GEOBB; EPO, JPO; USPAT; US-GEOBB; EPO, JPO; USPAT;	~	166	photoresist and PGMEA and (diffusion)		2003/10/21 19	:13
Part		}			1	- }
Second container) Seco					}	- }
Separate					}	- }
US-PGPUB; EPO, JPO; DERMENT; IEM TDB USPAT; US-PGPUB; EPO, JPO; DERMENT; IEM TDB USPAT; IEM TD	_	۹	(fluidizing and polymer) ti		2003/10/21 19	:14
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- 20 (solvent and resist and vapor).ab. USPAT; US-PGPUB (chamber or vessel)).ab. (solvent and resist and (chamber or vessel)).ab. (solvent and resist and (absorb\$3 or diffus\$3 or evaporat\$3 or permeat\$3)).ab. (solvent and resist).ab. and PGMEA ("3737499") or ("3597257") or ("3539381") or ("2138578")).PN. ("0243200" "2138578" "2294479" "3339526" "3539381" "3597257" "3737499").PN. (solvent and resist and (chamber or vessel or container)).ab. (solvent and resist or resist) and (chamber or vessel or ("5374693") or ("5965237")).PN. ("6004444") or ("5965237")).PN. ("6004444") or ("5965237")).PN. ("6004444") or ("5965237")).PN.	-	12	(solvent and photoresist and vapor).ab.		2003/10/21 19	:27
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